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Amendment and Response
Applicant: Joseph M. Torgerson et al.
Serial No.: 10/827,030
Filed: April 19, 2004
Docket No.: 200210152-1
Title: FLUID EJECTION DEVICE

IN THE CLAIMS

Please cancel claims 4, 22, 24-34, and 44 without prejudice.

Please add claims 64-69.

Please amend claims 1, 43, and 56 as follows:

1. (Currently Amended) A fluid ejection device comprising:
a substrate;
a first fluid feed slot formed in the substrate and having a first fluid feed slot edge;
first firing resistors disposed along the first fluid feed slot and first nozzle openings
each associated with one of the first firing resistors, wherein the first firing resistors are
configured to respond to a first current to heat fluid provided by the first fluid feed slot via a
fluid path and eject the fluid from the associated one of the first nozzle openings;
first conductive leads extending to respective ones of the first firing resistors, and
second conductive leads extending from respective ones of the first firing resistors; and
a reference conductor formed on the substrate and configured to conduct the first
current from the first firing resistors, wherein the reference conductor is disposed between
adjacent ones of the first firing resistors as associated with respective ones of the first nozzle
openings, between the first conductive leads and the second conductive leads of one of the
first firing resistors and the first conductive leads and the second conductive leads of an
adjacent one of the first firing resistors, and under the fluid path in an area between the first
fluid feed slot edge and the first firing resistors.
2. (Cancelled)
3. (Withdrawn) The fluid ejection device of claim 1, comprising drive switches,
wherein each of the drive switches is electrically coupled to a corresponding first firing
resistor of the first firing resistors and the reference conductor is disposed over a portion of
the drive switches.
4. (Cancelled)

Amendment and Response

Applicant: Joseph M. Torgerson et al.
Serial No.: 10/827,030
Filed: April 19, 2004
Docket No.: 200210152-1
Title: FLUID EJECTION DEVICE

5. (Withdrawn) The fluid ejection device of claim 1, comprising drive switches formed in a first layer and firing resistor areas formed in a second layer disposed along the first fluid feed slot, wherein the reference conductor is disposed between adjacent firing resistor areas and over a portion of the drive switches.
6. (Original) The fluid ejection device of claim 1, comprising drive switches, wherein each of the drive switches is electrically connected to a corresponding first firing resistor of the first firing resistors and the reference conductor.
7. (Original) The fluid ejection device of claim 1, comprising drive switches, wherein each of the drive switches is a field effect transistor that is electrically connected between a corresponding first firing resistor and the reference conductor.
8. (Previously Presented) The fluid ejection device of claim 1, wherein the reference conductor is disposed along the entire length of the first fluid feed slot.
9. (Previously Presented) The fluid ejection device of claim 1, wherein the reference conductor is disposed along opposing sides of the first fluid feed slot and along the entire length of the opposing sides of the first fluid feed slot.
10. (Previously Presented) The fluid ejection device of claim 1, wherein the first firing resistors are disposed along opposing sides of the first fluid feed slot and the reference conductor is disposed between the first firing resistors and the first fluid feed slot edge along one of the opposing sides of the first fluid feed slot and the first firing resistors and a second fluid feed slot edge along another one of the opposing sides of the first fluid feed slot.
11. (Previously Presented) The fluid ejection device of claim 1, comprising second firing resistors disposed along the first fluid feed slot and configured to respond to a second current to heat fluid provided by the first fluid feed slot, wherein the reference conductor is configured to conduct the second current from the second firing resistors and the reference conductor is disposed between the first fluid feed slot edge and the second firing resistors.

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Serial No.: 10/827,030
Filed: April 19, 2004
Docket No.: 200210152-1
Title: FLUID EJECTION DEVICE

12. (Previously Presented) The fluid ejection device of claim 11, wherein the second firing resistors are disposed on opposing sides of the first fluid feed slot and the reference conductor is disposed between the second firing resistors and the first fluid feed slot edge along one of the opposing sides of the first fluid feed slot and the second firing resistors and a second fluid feed slot edge along another one of the opposing sides of the first fluid feed slot.

13. (Previously Presented) The fluid ejection device of claim 11, comprising a second fluid feed slot and third firing resistors disposed along the second fluid feed slot and configured to respond to a third current to heat fluid provided by the second fluid feed slot, wherein the reference conductor is configured to conduct the third current from the third firing resistors, and the reference conductor is disposed between the third firing resistors and a second fluid feed slot edge along the second fluid feed slot.

14. (Previously Presented) The fluid ejection device of claim 13, wherein the third firing resistors are disposed on opposing sides of the second fluid feed slot and the reference conductor is disposed between the third firing resistors and the second fluid feed slot edge along one of the opposing sides of the second fluid feed slot and the third firing resistors and a third fluid feed slot edge along another one of the opposing sides of the second fluid feed slot.

15. (Previously Presented) The fluid ejection device of claim 13, comprising fourth firing resistors disposed along the second fluid feed slot and configured to respond to a fourth current to heat fluid provided by the second fluid feed slot, wherein the reference conductor is configured to conduct the fourth current from the fourth firing resistors and the reference conductor is disposed between the second fluid feed slot edge and the fourth firing resistors.

16. (Previously Presented) The fluid ejection device of claim 15, wherein the fourth firing resistors are disposed on opposing sides of the second fluid feed slot and the reference conductor is disposed between the fourth firing resistors and the second fluid feed slot edge along one of the opposing sides of the second fluid feed slot and the fourth firing resistors

Amendment and Response

Applicant: Joseph M. Torgerson et al.
Serial No.: 10/827,030
Filed: April 19, 2004
Docket No.: 200210152-1
Title: FLUID EJECTION DEVICE

and a third fluid feed slot edge along another one of the opposing sides of the second fluid feed slot.

17. (Previously Presented) The fluid ejection device of claim 15, comprising fifth firing resistors, wherein a first portion of the fifth firing resistors are disposed along the first fluid feed slot and configured to respond to a fifth current to heat fluid provided by the first fluid feed slot and a second portion of the fifth firing resistors are disposed along the second fluid feed slot and configured to respond to the fifth current to heat fluid provided by the second fluid feed slot, wherein the reference conductor is configured to conduct the fifth current from the fifth firing resistors and is disposed between the first fluid feed slot edge and the first portion of the fifth firing resistors and between the second fluid feed slot edge and the second portion of the fifth firing resistors.

18. (Previously Presented) The fluid ejection device of claim 17, comprising sixth firing resistors, wherein a first portion of the sixth firing resistors are disposed along the first fluid feed slot and configured to respond to a sixth current to heat fluid provided by the first fluid feed slot and a second portion of the sixth firing resistors are disposed along the second fluid feed slot and configured to respond to the sixth current to heat fluid provided by the second fluid feed slot, wherein the reference conductor is configured to conduct the sixth current from the sixth firing resistors and is disposed between the first fluid feed slot edge and the first portion of the sixth firing resistors and between the second fluid feed slot edge and the second portion of the sixth firing resistors.

19. (Previously Presented) The fluid ejection device of claim 1, comprising a second fluid feed slot having a second fluid feed slot edge and second firing resistors, wherein a first portion of the second firing resistors are disposed along the first fluid feed slot and configured to respond to a second current to heat fluid provided by the first fluid feed slot and a second portion of the second firing resistors are disposed along the second fluid feed slot and configured to respond to the second current to heat fluid provided by the second fluid feed slot, wherein the reference conductor is configured to conduct the second current from the second firing resistors and is disposed between the first fluid feed slot edge and the first

Amendment and Response

Applicant: Joseph M. Torgerson et al.
Serial No.: 10/827,030
Filed: April 19, 2004
Docket No.: 200210152-1
Title: FLUID EJECTION DEVICE

portion of the second firing resistors and between the second fluid feed slot edge and the second portion of the second firing resistors.

20. (Original) The fluid ejection device of claim 1, wherein the reference conductor comprises a conductive layer and a resistive layer.

21. (Previously Presented) The fluid ejection device of claim 1, comprising:
vaporization chambers fluidically coupled to the first fluid feed slot; and
an isolation layer configured to isolate the reference conductor from fluid flowing from the fluid feed slot to the vaporization chambers, wherein the reference conductor is disposed between adjacent vaporization chambers and between the vaporization chambers and the first fluid feed slot edge.

22-34. (Cancelled)

35. (Withdrawn) A fluid ejection device comprising:
a substrate;
a first fluid feed slot formed in the substrate and having a first fluid feed slot edge;
first firing resistors disposed along the first fluid feed slot and configured to respond to a first current to heat fluid provided by the first fluid feed slot via a fluid path;
first drive switches disposed along the first fluid feed slot, wherein each of the first drive switches is electrically coupled to one of the first firing resistors and configured to supply the first current to the one of the first firing resistors; and
a reference conductor formed on the substrate and disposed over a portion of the first drive switches and under the fluid path in an area between the first firing resistors and the first fluid feed slot edge,
wherein the reference conductor is configured to conduct the first current from the first firing resistors.

36. (Withdrawn) The fluid ejection device of claim 35, comprising vaporization chambers fluidically coupled to the first fluid feed slot, wherein each of the first firing

Amendment and Response

Applicant: Joseph M. Torgerson et al.
Serial No.: 10/827,030
Filed: April 19, 2004
Docket No.: 200210152-1
Title: FLUID EJECTION DEVICE

resistors is disposed substantially adjacent to a corresponding one of the vaporization chambers and the reference conductor is disposed between the vaporization chambers and the first fluid feed slot edge.

37. (Withdrawn) The fluid ejection device of claim 35, wherein the reference conductor is disposed between at least two of the first firing resistors.

38. (Withdrawn) The fluid ejection device of claim 35, wherein the reference conductor is disposed between at least two of the first firing resistors and between two of the first drive switches.

39. (Withdrawn) The fluid ejection device of claim 35, wherein the first firing resistors are disposed on opposing sides of the first fluid feed slot and the first drive switches are disposed on the opposing sides of the first fluid feed slot, and the reference conductor is disposed over a portion of the first drive switches and between the first firing resistors and the first fluid feed slot edge along one of the opposing sides of the first fluid feed slot and over a portion of the first drive switches and between a second fluid feed slot edge along another one of the opposing sides of the first fluid feed slot.

40. (Withdrawn) The fluid ejection device of claim 35, comprising:
a second fluid feed slot formed in the substrate and having a second fluid feed slot edge;

second firing resistors disposed along the second fluid feed slot and configured to respond to the first current to heat fluid provided by the second fluid feed slot via a second fluid path; and

second drive switches disposed along the second fluid feed slot, wherein each of the second drive switches is electrically coupled to one of the second firing resistors and configured to supply the first current to the one of the second firing resistors,

wherein the reference conductor is disposed over a portion of the second drive switches and under the second fluid path in an area between the second firing resistors and the second fluid feed slot edge,

Amendment and Response

Applicant: Joseph M. Torgerson et al.
Serial No.: 10/827,030
Filed: April 19, 2004
Docket No.: 200210152-1
Title: FLUID EJECTION DEVICE

wherein the reference conductor is configured to conduct the first current from the second firing resistors.

41. (Withdrawn) The fluid ejection device of claim 35, comprising:
second firing resistors disposed along the first fluid feed slot and configured to respond to a second current to heat fluid provided by the first fluid feed slot; and
second drive switches disposed along the first fluid feed slot, wherein each of the second drive switches is electrically coupled to one of the second firing resistors and the reference conductor is disposed over a portion of the second drive switches and extending to between the second firing resistors and the first fluid feed slot edge.

42. (Withdrawn) The fluid ejection device of claim 35, comprising:
a second fluid feed slot formed in the substrate and having a second fluid feed slot edge;
second firing resistors disposed along the second fluid feed slot and configured to respond to a second current to heat fluid provided by the second fluid feed slot via a second fluid path; and
second drive switches disposed along the second fluid feed slot, wherein each of the second drive switches is electrically coupled to one of the second firing resistors and configured to supply the second current to the one of the second firing resistors,
wherein the reference conductor is disposed over a portion of the second drive switches and under the second fluid path in an area between the second firing resistors and the second fluid feed slot edge,
wherein the reference conductor is configured to conduct the second current from the second firing resistors.

43. (Currently Amended) A method of operating a fluid ejection device, comprising:
receiving fluid via a fluid path at first firing resistors disposed along a first fluid feed slot formed in a substrate, the first fluid feed slot having a first fluid feed slot edge and the fluid path extending between the first fluid feed slot edge and the first firing resistors;

Amendment and Response

Applicant: Joseph M. Torgerson et al.
Serial No.: 10/827,030
Filed: April 19, 2004
Docket No.: 200210152-1
Title: FLUID EJECTION DEVICE

receiving a first current at the first firing resistors via first conductive leads extending to respective ones of the first firing resistors;

heating the fluid received from the first fluid feed slot in response to receiving the first current at the first firing resistors and ejecting the fluid from respective first nozzle openings each associated with one of the first firing resistors;

receiving the first current from the first firing resistors at a reference conductor via second conductive leads extending from respective ones of the first firing resistors, the reference conductor formed on the substrate between adjacent ones of the first firing resistors as associated with respective ones of the first nozzle openings, between the first conductive leads and the second conductive leads extending to and from one of the first firing resistors and the first conductive leads and the second conductive leads extending to and from an adjacent one of the first firing resistors, and under the fluid path in an area between the first fluid feed slot edge and the first firing resistors; and

conducting part of the first current through the reference conductor as disposed between the adjacent ones of the first firing resistors, between the first conductive leads and the second conductive leads extending to and from one of the first firing resistors and the first conductive leads and the second conductive leads extending to and from an adjacent one of the first firing resistors, and between the first fluid feed slot edge and the first firing resistors.

44. (Cancelled)

45. (Withdrawn) The method of claim 43, comprising:

gating the first current through drive switches; and

conducting a second part of the first current through the reference conductor as disposed over a portion of the drive switches.

46. (Withdrawn) The method of claim 45, comprising conducting the second part of the first current through the reference conductor along the entire length of the first fluid feed slot.

47. (Withdrawn) The method of claim 45, comprising receiving the first current from the first firing resistors on opposing sides of the first fluid feed slot.

Amendment and Response

Applicant: Joseph M. Torgerson et al.
Serial No.: 10/827,030
Filed: April 19, 2004
Docket No.: 200210152-1
Title: FLUID EJECTION DEVICE

48. (Withdrawn) The method of claim 45, comprising:

- receiving a second current at second firing resistors disposed along the first fluid feed slot;
- heating the fluid received from the first fluid feed slot in response to receiving the second current at the second firing resistors;
- receiving the second current from the second firing resistors at the reference conductor; and
- conducting part of the second current through the reference conductor as disposed between the first fluid feed slot edge and the second firing resistors.

49. (Withdrawn) The method of claim 48, comprising:

- receiving fluid via a second fluid path at second firing resistors disposed along a second fluid feed slot formed in the substrate, the second fluid feed slot having a second fluid feed slot edge and the second fluid path extending between the second fluid feed slot edge and the second firing resistors;
- receiving the first current at the second firing resistors;
- heating the fluid received from the second fluid feed slot in response to receiving the first current at the second firing resistors;
- receiving the first current from the second firing resistors at the reference conductor as formed on the substrate under the second fluid path in an area between the second fluid feed slot edge and the second firing resistors; and
- conducting a second part of the first current through the reference conductor as disposed between the second fluid feed slot edge and the second firing resistors.

50. (Withdrawn) The method of claim 45, comprising:

- receiving fluid via a second fluid path at second firing resistors disposed along a second fluid feed slot formed in the substrate, the second fluid feed slot having a second fluid feed slot edge and the second fluid path extending between the second fluid feed slot edge and the second firing resistors;
- receiving a second current at the second firing resistors;

Amendment and Response

Applicant: Joseph M. Torgerson et al.
Serial No.: 10/827,030
Filed: April 19, 2004
Docket No.: 200210152-1
Title: FLUID EJECTION DEVICE

heating the fluid received from the second fluid feed slot in response to receiving the second current at the second firing resistors;

receiving the second current from the second firing resistors at the reference conductor as formed on the substrate under the second fluid path in an area between the second fluid feed slot edge and the second firing resistors; and

conducting part of the second current through the reference conductor as disposed between the second fluid feed slot edge and the second firing resistors.

51-55. (Cancelled)

56. (Currently Amended) A fluid ejection device comprising:

a substrate;

a fluid feed slot formed in the substrate;

vaporization chambers fluidically coupled to the fluid feed slot via a fluid path;

nozzle openings each communicated with a respective one of the vaporization chambers;

firing resistors disposed in the vaporization chambers;

~~conductive leads extending to and from the firing resistors~~

first conductive leads extending to respective ones of the firing resistors and second conductive leads extending from respective ones of the firing resistors; and

a reference conductor disposed between adjacent ones of the firing resistors as communicated with respective ones of the nozzle openings, ~~between the conductive leads of the adjacent ones of the firing resistors between the first conductive leads and the second conductive leads extending to and from one of the firing resistors and the first conductive leads and the second conductive leads extending to and from an adjacent one of the firing resistors, and under the fluid path in an area between an edge of the fluid feed slot and the vaporization chambers.~~

57. (Original) The fluid ejection device of claim 56 comprising:

an isolation structure configured to isolate the reference conductor from fluid flowing through the fluid path.

Amendment and Response

Applicant: Joseph M. Torgerson et al.
Serial No.: 10/827,030
Filed: April 19, 2004
Docket No.: 200210152-1
Title: FLUID EJECTION DEVICE

58-63. (Cancelled)

64. (New) The fluid ejection device of claim 1, wherein each of the first firing resistors includes a first resistive segment, a second resistive segment, and a conductive shorting bar electrically coupled to the first resistive segment and the second resistive segment.

65. (New) The fluid ejection device of claim 64, wherein a respective one of the first conductive leads is electrically coupled to the first resistive segment of a respective one of the first firing resistors, and wherein a respective one of the second conductive leads is electrically coupled to the second resistive segment of the respective one of the first firing resistors.

66. (New) The method of claim 43, wherein each of the first firing resistors includes a first resistive segment; a second resistive segment, and a conductive shorting bar electrically coupled to the first resistive segment and the second resistive segment.

67. (New) The method of claim 66, wherein a respective one of the first conductive leads is electrically coupled to the first resistive segment of a respective one of the first firing resistors, and wherein a respective one of the second conductive leads is electrically coupled to the second resistive segment of the respective one of the first firing resistors.

68. (New) The fluid ejection device of claim 56, wherein each of the firing resistors includes a first resistive segment, a second resistive segment, and a conductive shorting bar electrically coupled to the first resistive segment and the second resistive segment.

69. (New) The fluid ejection device of claim 68, wherein a respective one of the first conductive leads is electrically coupled to the first resistive segment of a respective one of the firing resistors, and wherein a respective one of the second conductive leads is electrically coupled to the second resistive segment of the respective one of the firing resistors.